



*. C1 is a rework part.

Built on PMP9176 Rev A PCB

PCB: PMP9176 Rev A

PCB
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Number: PMP10767	Rev: A	Designed for: Public Release	Mod. Date: 10/13/2014
SVN Rev. Version control disabled	Assembly Variant: 001	Project Title: Buck converter with 85-264V _{in} (AC) and 15V _{out} 0.1A	Sheet Title:
Drawn By: S Yu	File: PMP9176RevA_01.SchDoc	Sheet: 1 of 1	Size: B
Engineer: S Yu	Contact: http://www.ti.com/support	http://www.ti.com	



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